### **Product Data Sheet**

# DIAION™ USMN1

DIAION™ USMN1 is a nuclear grade mixed resin with strongly acidic cation exchange resin, DIAION™ UBKN1, and strongly basic anion exchange resin, DIAION™ UBAN1. It is used for cleanup system in primary circuit, cleanup system SFP, radwaste, etc.

#### **Product**

Grade Name	DIAION <sup>TM</sup> USMN1
Туре	Mixed
Matrix	Styrene-DVB, Gel
Functional Group	Sulfonic acid / Type I (trimethyl ammonium groups)
Ionic Form	H <sup>+</sup> / OH <sup>-</sup>
Chemical Equivalent Ratio	1/1

## Specification

Component		Cation Exchange Resin	Anion Exchange Resin
		DIAION <sup>TM</sup> UBKN1	DIAION <sup>TM</sup> UBAN1
Whole Bead Count	-	90 min.	-
Salt Splitting Capacity	meq/mL	2.4 min.	1.2 min.
Particle Size Distribution on 1180 μm	%	-	0.5 max.
Particle Size Distribution thr. 425 μm	%	1.0 max.	1.0 max.
Particle Size Distribution 425 - 1180 μm	%	95 min.	-
Mean Particle Size	μm	650 ± 50	$630 \pm 50$
Uniformity Coefficient	-	-	1.2 max.
Ionic Form Conversion H Form	eq%	99 min.	-
Ionic Form Conversion Na Form	eq%	0.1 max.	-
Ionic Form Conversion OH Form	eq%	-	95 min.
Ionic Form Conversion CO <sub>3</sub> Form	eq%	-	5 max.
Ionic Form Conversion Cl Form	eq%	-	0.2 max.
Metal Content (Ca)	mg/L	50 max.	50 max.
Metal Content (Pb)	mg/L	10 max.	10 max.
Metal Content (Fe)	mg/L	50 max.	50 max.
Metal Content (Cu)	mg/L	10 max.	10 max.
Water Extractables	g/L-R	0.1 max.	0.1 max.

## **Typical Properties**

Component	Mixed Resin
Shipping Density g/L	730
Pasammandad Operating Conditions	

## **Recommended Operating Conditions**

Maximum Operating Temperature	°C	60
Operating pH Range		0 - 14
Minimum Bed Depth	mm	800
Service Flow Rate	m/h	10 - 60



#### **Hydraulic Characteristics**

The approximate pressure drop at various temperatures and flow rates for each meter of bed depth of DIAION<sup>TM</sup> USMN1 resin in normal down flow operation is shown in the graphs below.

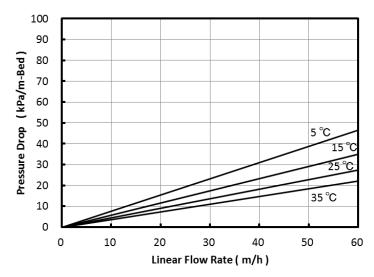


Fig. 1 Pressure Drop of USMN1

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